



# Y.LIN ELECTRONICS CO.,LTD.

## Data Sheet

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Customer: \_\_\_\_\_  
Part No: YLS191/RGB/21/06-H  
Sample No: YL20180118-415Y  
Description: 0603 Red/Green/Blue SMD  
Item No: \_\_\_\_\_

Customer			
Check	Inspection	Approval	Date

Y.LIN			
Drawn	Check	Approval	Date
			2017/8/8

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**Features:**

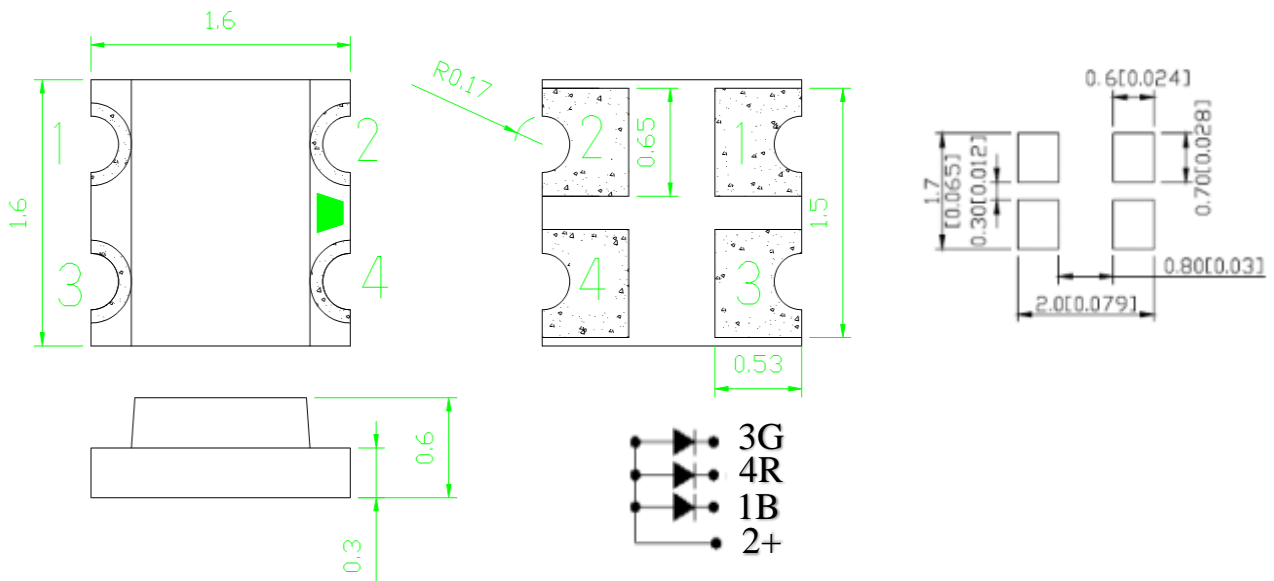
- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

**Technical Data Sheet**

This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard.

**Applications**

- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use



**Notes:**

- 1 . All dimension units are millimeters.
2. All dimension tolerance is  $\pm 0.2$ mm unless otherwise noted.



### Selection Guide

Part No.	Dice	Lens Type	Luminous intensity(mcd) @ 20mA			Viewing Angle
			Min	Typ	Max	2θ1/2
YLS191/RGB/21/06-H	(R) AlGaInP	Water Clear	70	--	200	120
	(G) InGaIn		400	--	600	
	(B) InGaIn		70	--	200	

Note:

- 1.1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.the above luminous intensity measurement allowance tolerance  $\pm 10\%$

### Electrical / Optical Characteristics at Ta=25 °C

Parameter	Symbol	Min.	Typ.	Max.	Units	test conditions
Forward Voltage	R	1.8	--	2.4	V	IF=20mA
	G	2.7	--	3.3		
	B	2.7	--	3.3		
Reverse Current	IR	--	--	10	uA	VR = 5V
Dominate Wavelength	R	615	--	630	nm	IF=20mA
	G	515	--	530		
	B	460	--	475		

### Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Rating	Units
Power Dissipation	R	60	mW
	G	90	
	B	90	
DC Forward Current	IF	20	mA
Peak Forward Current [1]	IFP	40	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	R	2000	V
	G	2000	
	B	2000	
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

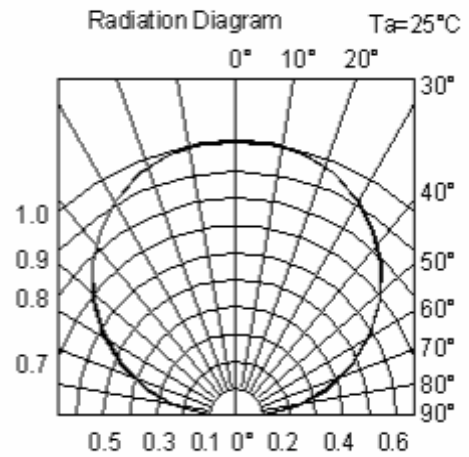
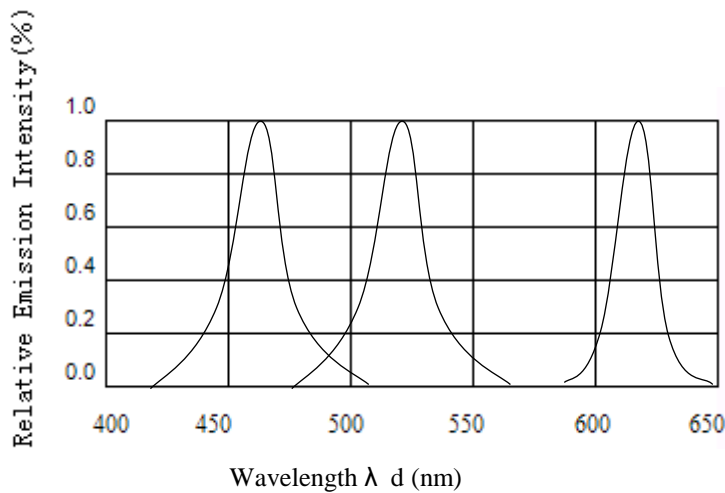
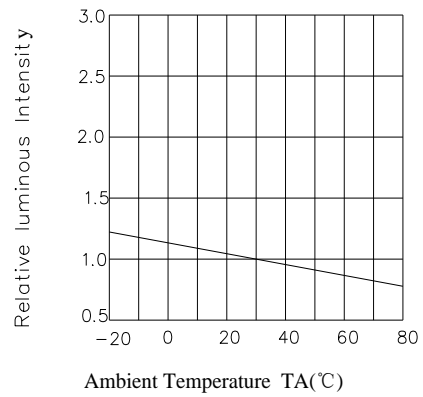
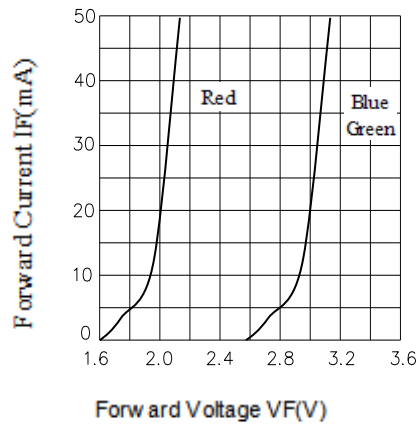
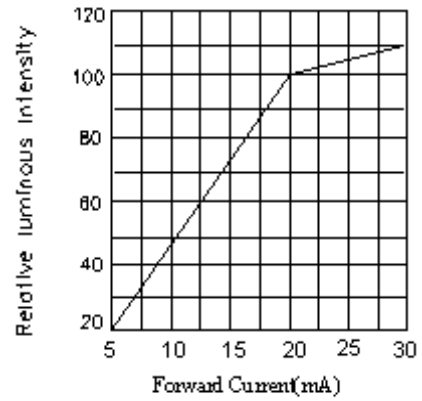
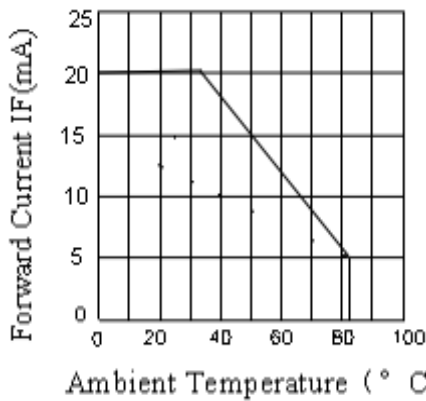
Note:

1. 1/10 Dut cycle,0.1ms pulse width.
2. The above forward voltage measurement allowance tolerance  $\pm 0.1V$ .
3. The tolerance of wave length:  $\pm 1nm$ .



### Typical optical characteristics curves

Ambient Temperature VS. Forward Current





**Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level :90%

LTPD :10%

Test Items	Test conditions	Quantity	Judging Criteria
Solderability	Solder Temperature: 240°C Solder Duration: (3.5±0.5) sec.	22	Solderable Area Over 95%
Thermal Shock Followed by High Temperature And High Humidity Cyclic	-40°→10min 5 Cycles ↑ ↓ shift(2~3)min 100°C →10 min. 25°C~55°C (90%~95%) RH 2 Cycles for 48 hrs., Recover for 2 hrs	22	C=0 & I**
Resistance For Soldering Heat	Reflow Soldering	22	C=0 & I**
DC Operating Life	1000 hrs. Forward Current: 20mA	22	C=0 & I**
High Temperature Storage	100°C → 1000 hrs	22	C=0 & I**
High Temperature And High Humidity Cyclic	25°C~55°C (90%~95%) RH 6 Cycles for 144 hrs., Recover for 2 hrs.	22	C=0 & I**

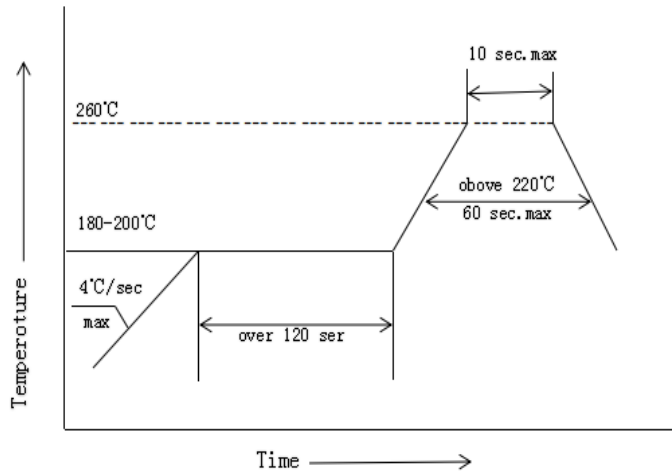
The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products.It does not constitute the warranting of industrial property nor the granting of any license.



### SMT Reflow Soldering Instructions

1.Reflow soldering should not exceed once.

2.In soldering process , do not stress on the LEDs during heating .

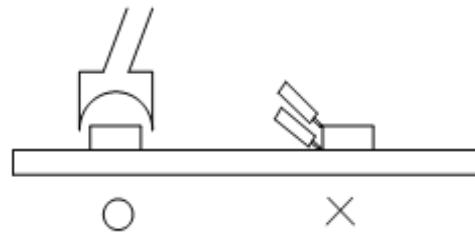


### Soldering iron

- 1.When hand soldering, the temperature of the iron must lower than 300°C for 3 seconds
- 2.The hand solder should be done only one time

### Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



### Storage

The package is sealed:

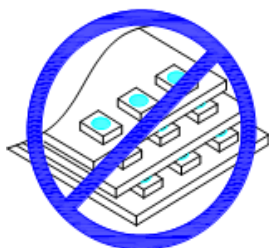
- 1.Recommended storage condition :At 5°C~30°C and relative humidity 90% RH max.
- 2.It is recommended that SMD out of their original packaging are used within one year.

The package is opened:

- 1.After this bag is opened ,devises that will be applied to infrared to infrared reflow,vapor-phase reflow.
  - a.Completed within 672 hour.
  - b.Stored at 5°C~30°C and 60% RH or less.
- 2.If baking is required,devices must be baked under below conditions 24 hours at 60°C±3°C

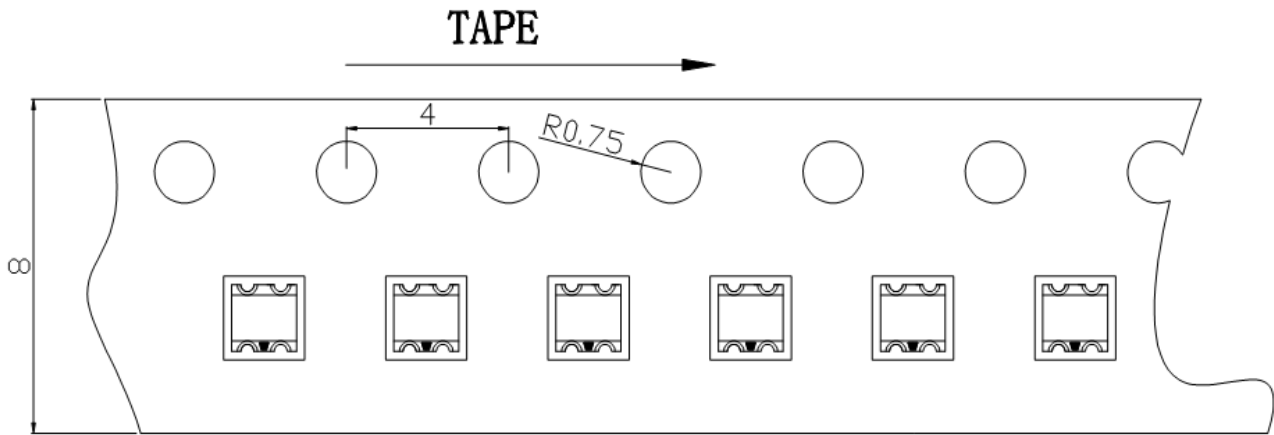
### Handling Precautions

- 1.Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage.
- 2.Not available in the situation of acidity for PH.





**Packaging**



Package: 4000 pcs/reel

Note: The tolerances unless mentioned is  $\pm 0.1$ mm, Unit: mm

**Moisture Resistant Packaging**

